

Appl. No. 09/730,932
Amdt. dated August 6, 2003

PATENT

REMARKS/ARGUMENTS

Claims 1-6 are pending.

Claims 1-4 stand rejected under 35 USC §102(e) as being clearly anticipated by Pu.

Claims 3-6 stand rejected under 35 USC §103(a) as being unpatentable over Pu et al. in view of Tagawa et al. and Choi et al.

These rejections are respectfully traversed and reconsideration is respectfully requested.

Applicant has amended claim 1 to make it clear that the lead frame includes a single common base and has a plurality of legs extending therefrom. This can clearly be seen in figure 1 of the present application. The first die is coupled to a first side of the base with solder while a second die is coupled to a second side of the base opposite the first side with solder.

It is respectfully submitted that Pu et al. disclose a plurality of leads, with each lead being individually coupled to each die. The leads are not extending from a common base. Accordingly, it is respectfully submitted that Pu et al. do not anticipate claim 1 and therefore, claim 1 is allowable.

Claims 2-6 depend, either directly or indirectly on claim 1 and therefore, they are allowable for at least the reasons for at least the reasons claim 1 is allowable.

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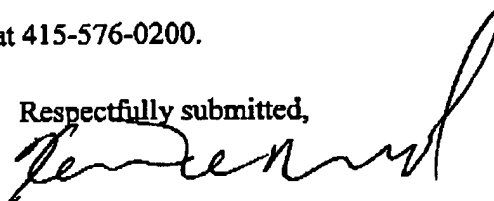
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CONCLUSION

In view of the foregoing, Applicants believe all claims now pending in this Application are in condition for allowance and an action to that end is respectfully requested.

If the Examiner believes a telephone conference would expedite prosecution of this application, please telephone the undersigned at 415-576-0200.

Respectfully submitted,



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